# **BAS40-06LT1**

Preferred Device

# **Common Anode Schottky Barrier Diodes**

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

# Features

- Extremely Fast Switching Speed
- Low Forward Voltage
- Pb-Free Package is Available

### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Reverse Voltage	$V_R$	40	V

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Forward Power Dissipation  © T <sub>A</sub> = 25°C  Derate above 25°C	P <sub>F</sub>	225 1.8	mW mW/°C
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Forward Continuous Current	I <sub>FM</sub>	120	mA
	I <sub>FSM</sub>	200 600	mA
Thermal Resistance  Junction-to-Ambient	R <sub>θJA</sub>	508 (Note 1) 311 (Note 2)	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

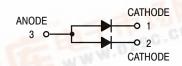
- 1. FR-4 @ minimum pad.
- 2. FR-4 @ 1.0 x 1.0 in pad.



# ON Semiconductor®

http://onsemi.com

# 40 VOLTS SCHOTTKY BARRIER DIODE





SOT-23 (TO-236AB) CASE 318 STYLE 12

#### MARKING DIAGRAM



L2 = Specific Device Code

M = Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location)
\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

# **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
BAS40-06LT1	SOT-23	3000/Tape & Reel
BAS40-06LT1G	SOT-23 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.



# BAS40-06LT1

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Reverse Breakdown Voltage $(I_R = 10 \mu A)$	V <sub>(BR)R</sub>	40	-	V
Total Capacitance (V <sub>R</sub> = 1.0 V, f = 1.0 MHz)	C <sub>T</sub>	_	5.0	pF
Reverse Leakage (V <sub>R</sub> = 25 V)	I <sub>R</sub>	-	1.0	μAdc
Forward Voltage (I <sub>F</sub> = 1.0 mAdc)	V <sub>F</sub>	-	380	mVdc
Forward Voltage (I <sub>F</sub> = 10 mAdc)	V <sub>F</sub>	-	500	mVdc
Forward Voltage (I <sub>F</sub> = 40 mAdc)	V <sub>F</sub>	-	1.0	Vdc

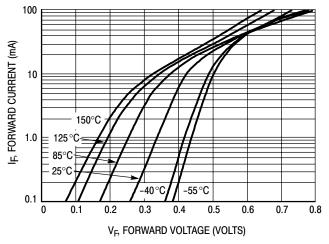


Figure 1. Typical Forward Voltage

Figure 2. Reverse Current versus Reverse Voltage

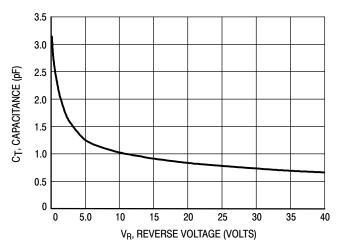


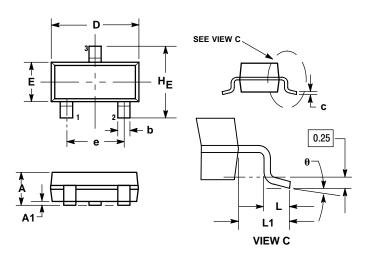
Figure 3. Typical Capacitance

http://opcomi.com

# BAS40-06LT1

# **PACKAGE DIMENSIONS**

SOT-23 (TO-236) CASE 318-08 **ISSUE AN** 



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER

  - ANSI Y14.5M, 1982.

    CONTROLLING DIMENSION: INCH.

    MAXIMUM LEAD THICKNESS INCLUDES
    LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
  - BASE MATERIAL.

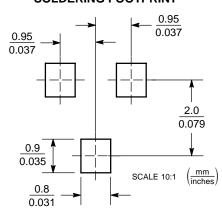
    4. 318-01 THRU -07 AND -09 OBSOLETE,
    NEW STANDARD 318-08.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.89	1.00	1.11	0.035	0.040	0.044	
A1	0.01	0.06	0.10	0.001	0.002	0.004	
b	0.37	0.44	0.50	0.015	0.018	0.020	
С	0.09	0.13	0.18	0.003	0.005	0.007	
D	2.80	2.90	3.04	0.110	0.114	0.120	
E	1.20	1.30	1.40	0.047	0.051	0.055	
е	1.78	1.90	2.04	0.070	0.075	0.081	
L	0.10	0.20	0.30	0.004	0.008	0.012	
L1	0.35	0.54	0.69	0.014	0.021	0.029	
HE	2.10	2.40	2.64	0.083	0.094	0.104	

#### STYLE 12:

- PIN 1. CATHODE 2. CATHODE
  - ANODE

# **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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